Electronic Supplementary Information for

Pulse laser deposited n-Si/NiO_x photoanodes for stable and

efficient photoelectrochemical water splitting

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Fig. S1. Grazing incidence XRD patterns of the n-Si and n-Si/NiO_x films.



Fig. S2. (a-c) The electrochemical activation behaviors of NiO_x deposited n-Si by PLD with different thickness (a: 1000 s, b: 3000 s and c: 5000 s). (d) Tafel plots of the n-Si/NiO_x (5000 s) photoanode with different activation scan cycles. (e) The Ni 2p XPS spectra of the n-Si/NiO_x (5000 s) photoanode before and after electrochemical activation. All CV measurements (20 mV s⁻¹) were scanned in 1.0 M NaOH (aq) at room temperature.



Fig. S3. Chronoamperometry of an n-Si/NiO_x (5000 s) photoanode held at 2 V vs. RHE in 1.0 M NaOH (aq). The illumination intensity was 1.0 Sun.